1	Applica	able stand	ard 3	UL : UL1977, C-UL : CSA2	22.2 No.18	32.3-M1	987, -	TÜV : EN	V61984	4:2009 ⁽³⁾			
						Operating Temperature Range		nge	FE 00 to 105 00				
		Volta	ge	600 V AC/DC		Operat Humid) Storag		ng Relative I / Range (N		Relative Humidity (Not dewe		max	
RA	TING	Curre	ent 🔬	25 A (AMBIENT TEPM 25°C 18 A (UL/C-UL)						-10 °C to 6	to 60 °C ⁽²⁾		
		2		19 A (TÜV)					e 40 % to 7	to 70 % ⁽²⁾			
			•		IFICA	TION	S						
	ITE			TEST METHOD			REQUIREMENTS					AT	
		CTION	•										
General Examination			Visually and by measuring instrument.				According to drawing.					×	
Marki	0		Confirmed								×	×	
		CHARAC											
	act Resis		10 mA(DC or 1000Hz)				2 m Ω N				×	—	
Insulation Resistance			1000 V DC.					1ΩMIN.			×	-	
	ge Proof		1800 V AC for 1 min. No flashover or breakdown.							×	-		
MEC	HANIC	CAL CHAR	ACTERIS	STICS									
Insertion and Withdrawal Forces			Measured by applicable connector.				Insertion Force: 10 N MAX. Withdrawal Force: 0.4 N MIN.				×	-	
Mechanical Operation			100 times insertions and extractions.				 Contact Resistance: 5 m Ω MAX. No domage, grack and loosenees of parts. 					-	
Vihrat	ion		Frequency 10 to 55 to 10Hz, approx 5min				 ② No damage, crack and looseness of parts. ① No electrical discontinuity of 1 µs. 					-	
Vibration			Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				 No damage, crack and looseness of parts. 						
Shock			490 m/s ² , duration of pulse 11 ms, 3 times to both directions in 3 axial directions.								×	-	
FNV		IENTAL C		ERISTICS									
Damp				at 40 ± 2 °C, 90 ~ 95 %,	96 + 4h	(tact Res	sistanc	e: 5mΩ MAX.	×	_	
(Steady State)							 ② Insulation Resistance: 1000 MΩ MIN. ③ No damage, crack and looseness of parts. 						
Rapid Change of Temperature			Temperature $-55 \rightarrow +105 \ ^{\circ}C$ Time $30 \rightarrow 30$ min. under 5 cycles.								×	-	
			(Relocation time to chamber: within 2~3 MIN)										
Dry heat			Exposed at $\pm 105 \pm 2^{\circ}$ C for 96 ± 4 h.								×	_	
Cold			Exposed at -55±2°C for 96±4h.									-	
Sulfur Dioxide			Exposed at 25±2°C, 75±5%RH, 25 PPM for 96h±4h.				 Contact Resistance: 5m Ω MAX. No defect such as corrosion which impairs 				×	-	
Resist	tance to		Solder bath : Solder temperature $260\pm5^{\circ}$ C				the function of connector. No deformation of case of excessive looseness					_	
Soldering Heat			for immersion, duration 10±1sec. Soldering irons : 380°C MAX. for 10 sec.				of the terminal.						
			Soldered at solder temperature $240\pm3^{\circ}$ C for immersion, duration 3 sec.				A new uniform coating of solder shall cover a x — minimum of 95 % of the surface being immersed.					-	
	COUNT	. D	ESCRIPTIC	TION OF REVISIONS		DESIG	ESIGNED CHECK			CHECKED	D	ATE	
∕3∖	4			F-00001906		TS. 00	ONO			HT. YAMAGUCHI		16. 12. 16	
REM/				ture rise caused by current-carrying. s a long-term storage state roduct before assembly to PCB. :2 type of terminals :dip solder contacts.				APPRC		HS. OKAWA		13.03.07	
	(3)							CHECI		KI. HIROKAWA		13.03.07	
		-						DESIG DRAV		DK. AIMOTO DK. AIMOTO	13.03.07 13.03.07		
Linia	Unless otherwise specified, refer to JIS-C-5402,IEC60512. Note QT:Qualification Test AT:Assurance Test X:Applicable Tes						DRAWING N		VIN	ELC4-35040			
	OTOU						PART NO.		FX30B-2P-7. 62DSA2				
Note			PECIE	CATION SHEET		PART	NO.		FΧ	30B-2P-7 62DSA2	0		

FORM HD0011-2-1

